









ProLight PJ2N-1FxE-2
1W Power LED
Technical Datasheet
Version: 1.9

# **ProLight Opto PJ2N Series**

### **Features**

- · Good color uniformity
- · Lead free reflow soldering
- · RoHS compliant
- · Instant light (less than 100ns)
- · No UV

### **Main Applications**

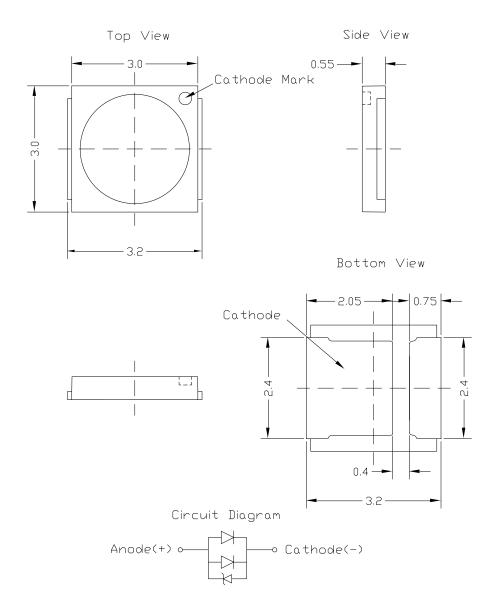
- · T8/T5 tube
- · LED bulb
- · Indoor/Outdoor Commercial and Residential Architectural

### Introduction

·PJ2N qualifies as the JEDEC Level 1 MSL sensitivity level and suitable for SMD process, Pb\_free reflow soldering capability, and full compliance with EU Reduction of Hazardous Substances (RoHS) legislation.



### **Emitter Mechanical Dimensions**



#### Notes:

- 1. Drawing not to scale.
- 2. All dimensions are in millimeters.
- 3. Unless otherwise indicated, tolerances are  $\pm$  0.1mm.
- 4. Please do not solder the emitter by manual hand soldering, otherwise it will damage the emitter.
- 5. Please do not use a force of over 0.3kgf impact or pressure on the lens of the LED, otherwise it will cause a catastrophic failure.

<sup>\*</sup>The appearance and specifications of the product may be modified for improvement without notice.



## Flux Characteristics at 300mA, $T_1 = 25^{\circ}C$

Radiation	Color	Part Number	Luminous F	Luminous Flux $\Phi_{V}$ (lm)		
Pattern	COIOI	Emitter		Typical	Minimum	
Flat	White	PJ2N-1FWE-2	110	128	70	
	Neutral White	PJ2N-1FNE-2	110	124	70	

- ProLight maintains a tolerance of ± 7% on flux and power measurements.
- ProLight maintains a tolerance of ± 2 on CRI measurements.
- Please do not drive at rated current more than 1 second without proper heat sink.

## Electrical Characteristics at 300mA, T<sub>J</sub> = 25°C

Color	Fo	rward Voltage V <sub>F</sub>	Thermal Resistance	
	Min.	Тур.	Max.	Junction to Slug (°C/W)
White	2.8	3.2	3.6	10
Neutral White	2.8	3.2	3.6	10

ProLight maintains a tolerance of ± 0.1V for Voltage measurements.

### Optical Characteristics at 300mA, $T_1 = 25$ °C

Radiation	Color	Colo	r Temperature	· CCT	Total included Angle (degrees)	Viewing Angle (degrees)
Pattern	Coloi	Min.	Тур.	Max.	θ <sub>0.90V</sub>	2 θ <sub>1/2</sub>
Flat	White Neutral White	4745 K 3700 K	5850 K 3975 K	6950 K 4250 K	160 160	120 120

<sup>•</sup> ProLight maintains a tolerance of ± 5% for CCT measurements.



## Electro-Optical Characteristics, T<sub>J</sub> = 25°C

I (m A)	V ()()	Dower (M/)	PJ2N-1I	PJ2N-1FWE-2		FNE-2
I <sub>F</sub> (mA)	V <sub>F</sub> (V)	Power (W)	Flux (lm)	lm/W	Flux (lm)	lm/W
100	2.88	0.29	50.2	174.6	48.7	169.1
150	2.97	0.45	72.0	161.7	69.8	156.6
200	3.05	0.61	92.1	150.8	89.2	146.1
250	3.13	0.78	110.7	141.6	107.3	137.2
300	3.20	0.96	128.0	133.3	124.0	129.2
350	3.27	1.14	144.4	126.2	139.9	122.3
400	3.33	1.33	159.1	119.4	154.1	115.6

All values are reference only.

### **Absolute Maximum Ratings**

Parameter	White/Neutral White		
DC Forward Current (mA)	400		
Peak Pulsed Forward Current (mA)	500 (less than 1/10 duty cycle@1KHz)		
ESD Sensitivity (HBM per MIL-STD-883E Method 3015.7)	±4000V (Class III)		
LED Junction Temperature	130°C		
Operating Board Temperature at Maximum DC Forward Current	-40°C - 90°C		
Storage Temperature	-40°C - 120°C		
Soldering Temperature	JEDEC 020c 260°C		
Allowable Reflow Cycles	3		
Reverse Voltage	Not designed to be driven in reverse bias		



### **Photometric Luminous Flux Bin Structure**

Color	Bin Code	Minimum Photometric Flux (Im)	Maximum Photometric Flux (Im)	Available Color Bins
	V1	110	120	[1]
	V2	120	130	All
White	W1	130	140	All
	W2	140	155	[1]
	X1	155	170	[1]
	V1	110	120	All
Neutral White	V2	120	130	All
	W1	130	140	[1]

- $\bullet$  ProLight maintains a tolerance of  $\pm$  7% on flux and power measurements.
- The flux bin of the product may be modified for improvement without notice.
- [1] The rest of color bins are not 100% ready for order currently. Please ask for quote and order Possibility.

### **Forward Voltage Bin Structure**

Color	Bin Code	Minimum Voltage (V)	Maximum Voltage (V)
	Α	2.8	2.9
	В	2.9	3.0
	D	3.0	3.1
White	E	3.1	3.2
vvriite	F	3.2	3.3
	G	3.3	3.4
	Н	3.4	3.5
	J	3.5	3.6
	Α	2.8	2.9
	В	2.9	3.0
	D	3.0	3.1
Neutral White	E	3.1	3.2
ineutial Wille	F	3.2	3.3
	G	3.3	3.4
	Н	3.4	3.5
	J	3.5	3.6

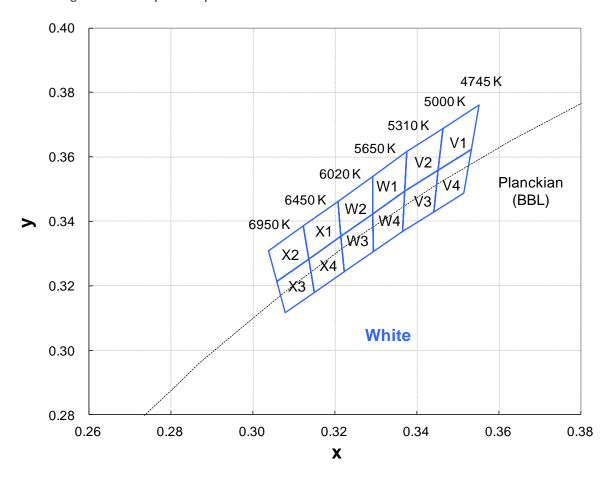
ProLight maintains a tolerance of ± 0.1V for Voltage measurements.

Note: Although several bins are outlined, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all colors.



### **Color Bin**

**White Binning Structure Graphical Representation** 





### **Color Bin**

**White Bin Structure** 

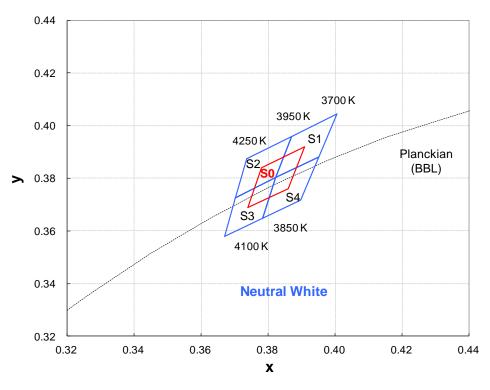
Bin Code	х	у	Typ. CCT (K)	Bin Code	х	у	Typ. CCT (K)
	0.3464	0.3688			0.3207	0.3462	_
V1	0.3551	0.3760	4870	W2	0.3292	0.3539	5830
VI	0.3533	0.3624	4070	VVZ	0.3293	0.3423	3630
	0.3452	0.3558			0.3215	0.3353	
	0.3452	0.3558			0.3215	0.3353	
V4	0.3533	0.3624	4870	W3	0.3293	0.3423	5830
V <del>4</del>	0.3515	0.3487	4070	VVS	0.3294	0.3306	3030
	0.3441	0.3428			0.3222	0.3243	
	0.3376	0.3616			0.3123	0.3385	
V2	0.3464	0.3688	5155	X1	0.3207	0.3462	6240
٧Z	0.3452	0.3558	3133	Λī	0.3215	0.3353	
	0.3371	0.3493			0.3136	0.3283	
	0.3371	0.3493			0.3136	0.3283	
V3	0.3452	0.3558	5155	X4	0.3215	0.3353	6240
٧٥	0.3441	0.3428	3133	7.4	0.3222	0.3243	0240
	0.3366	0.3369			0.3150	0.3180	
	0.3292	0.3539			0.3038	0.3308	
W1	0.3376	0.3616	5475	X2	0.3123	0.3385	6700
V V I	0.3371	0.3493	3473	ΛZ	0.3136	0.3283	0700
	0.3293	0.3423			0.3058	0.3213	
	0.3293	0.3423			0.3058	0.3213	
W4	0.3371	0.3493	5475	Х3	0.3136	0.3283	6700
v v <del></del>	0.3366	0.3369	0470	7.0	0.3150	0.3180	0700
	0.3294	0.3306			0.3078	0.3117	

<sup>•</sup> Tolerance on each color bin (x , y) is ± 0.005



### **Color Bin**

**Neutral White Binning Structure Graphical Representation** 



#### **Neutral White Bin Structure**

Bin Code	x	у	Typ. CCT (K)	Bin Code	х	у	Typ. CCT (K)
	0.3871	0.3959			0.3736	0.3874	
S1	0.4006	0.4044	3825	S2	0.3871	0.3959	4100
31	0.3952	0.3880	3023	32	0.3823	0.3803	4100
	0.3823	0.3803			0.3703	0.3726	
	0.3823	0.3803			0.3703	0.3726	
S4	0.3952	0.3880	3825	S3	0.3823	0.3803	4100
34	0.3898	0.3716	3023		0.3784	0.3647	4100
	0.3784	0.3647			0.3670	0.3578	
	0.3740	0.3690					
20	0.3780	0.3840	3975				
S0	0.3910	0.3920	39/5				
	0.3860	0.3760					

• Tolerance on each color bin (x , y) is ± 0.005

#### Note:

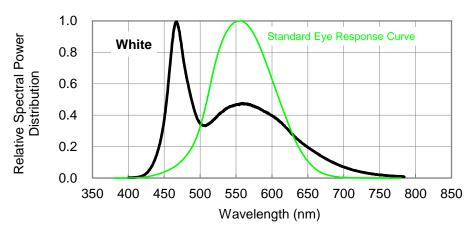
- 1. Although several bins are outlined, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all colors.
- 2. ProLight SmartBin is working to make the color bin smarter, by selecting that intelligence is infused into major S0 bin with minor S1-S4 bins and processes that make assembly easily

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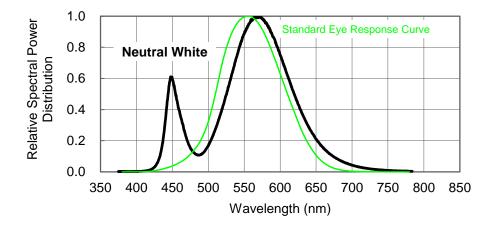


# Color Spectrum, $T_J = 25^{\circ}C$

#### 1. White



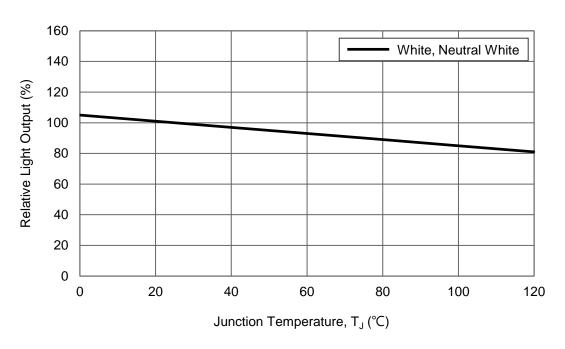
#### 2. Neutral White



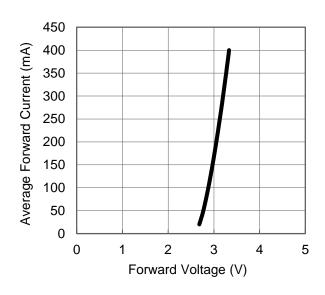


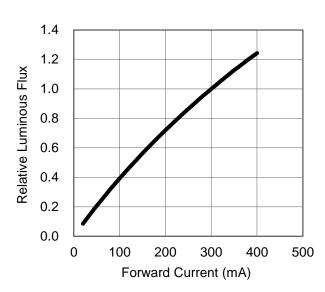
## **Light Output Characteristics**

Relative Light Output vs. Junction Temperature at 300mA



## Forward Current Characteristics, T<sub>J</sub> = 25°C

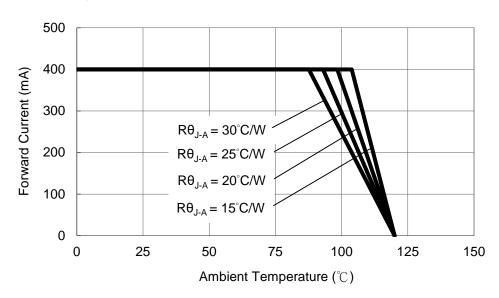




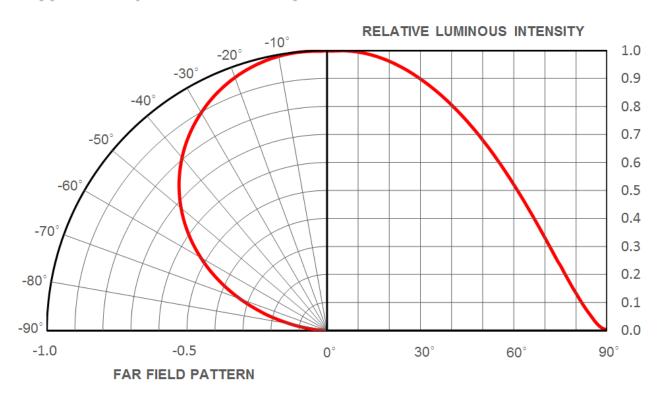


### **Ambient Temperature vs. Maximum Forward Current**

1. White, Neutral White (T<sub>JMAX</sub> = 120°C)



### **Typical Representative Spatial Radiation Pattern**



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### **Moisture Sensitivity Level - JEDEC Level 1**

			Soak Requirements				
Level	Floor Life		Stan	dard	Accelerated Environment		
	Time	Conditions	Time (hours)	Conditions	Time (hours)	Conditions	
1	Unlimited	≤30°C / 85% RH	168 +5/-0	85°C / 85% RH	NA	NA	

- The standard soak time includes a default value of 24 hours for semiconductor manufature's exposure time (MET) between bake and bag and includes the maximum time allowed out of the bag at the distributor's facility.
- Table below presents the moisture sensitivity level definitions per IPC/JEDEC's J-STD-020C.

				Soak Req	uirements		
Level	Flooi	r Life	Stan	dard	Accelerated	Accelerated Environment	
	Time	Conditions	Time (hours)	Conditions	Time (hours)	Conditions	
1	Unlimited	≤30°C / 85% RH	168 +5/-0	85°C / 85% RH	NA	NA	
2	1 year	≤30°C / 60% RH	168 +5/-0	85°C / 60% RH	NA	NA	
2a	4 weeks	≤30°C / 60% RH	696 +5/-0	30°C / 60% RH	120 +1/-0	60°C / 60% RH	
3	168 hours	≤30°C / 60% RH	192 +5/-0	30°C / 60% RH	40 +1/-0	60°C / 60% RH	
4	72 hours	≤30°C / 60% RH	96 +2/-0	30°C / 60% RH	20 +0.5/-0	60°C / 60% RH	
5	48 hours	≤30°C / 60% RH	72 +2/-0	30°C / 60% RH	15 +0.5/-0	60°C / 60% RH	
5a	24 hours	≤30°C / 60% RH	48 +2/-0	30°C / 60% RH	10 +0.5/-0	60°C / 60% RH	
6	Time on Label (TOL)	≤30°C / 60% RH	Time on Label (TOL)	30°C / 60% RH	NA	NA	



## **Qualification Reliability Testing**

Stress Test	Stress Conditions	Stress Duration	Failure Criteria
Room Temperature Operating Life (RTOL)	25°C, I <sub>F</sub> = max DC (Note 1)	1000 hours	Note 2
Wet High Temperature Operating Life (WHTOL)	$85^{\circ}$ C/60%RH, I <sub>F</sub> = max DC (Note 1)	1000 hours	Note 2
Wet High Temperature Storage Life (WHTSL)	85°C/85%RH, non-operating	1000 hours	Note 2
High Temperature Storage Life (HTSL)	110°C, non-operating	1000 hours	Note 2
Low Temperature Storage Life (LTSL)	-40°C, non-operating	1000 hours	Note 2
Non-operating Temperature Cycle (TMCL)	-40°C to 120°C, 30 min. dwell, <5 min. transfer	200 cycles	Note 2
Mechanical Shock	1500 G, 0.5 msec. pulse, 5 shocks each 6 axis		Note 3
Natural Drop	On concrete from 1.2 m, 3X		Note 3
Variable Vibration Frequency	10-2000-10 Hz, log or linear sweep rate, 20 G about 1 min., 1.5 mm, 3X/axis		Note 3
Solder Heat Resistance (SHR)	260°C ± 5°C, 10 sec.		Note 3
Solderability	Steam age for 16 hrs., then solder dip at 260°C for 5 sec.		Solder coverage on lead

#### Notes:

- 1. Depending on the maximum derating curve.
- 2. Criteria for judging failure

Item	Test Condition	Criteria for Judgement	
		Min.	Max.
Forward Voltage (V <sub>F</sub> )	$I_F = max DC$		Initial Level x 1.1
Luminous Flux or Radiometric Power $(\Phi_V)$	I <sub>F</sub> = max DC	Initial Level x 0.7	

<sup>\*</sup> The test is performed after the LED is cooled down to the room temperature.

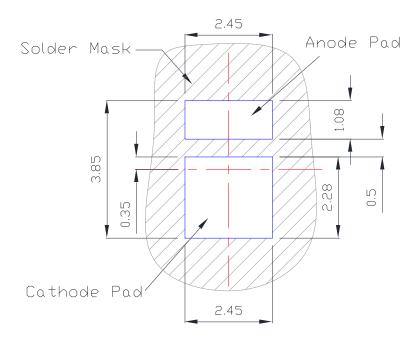
3. A failure is an LED that is open or shorted.



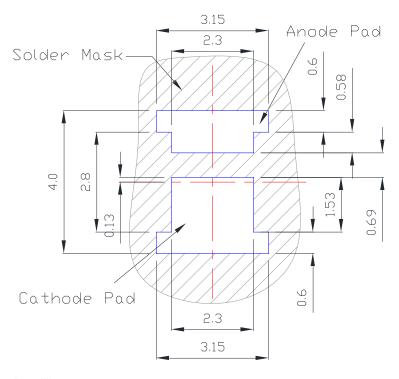
# **Recommended Solder Pad Design**

**Standard Emitter** 

TYPE A.



TYPE B.

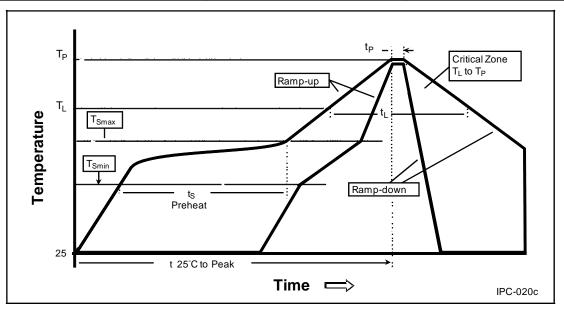


All dimensions are in millimeters.



### **Reflow Soldering Condition**

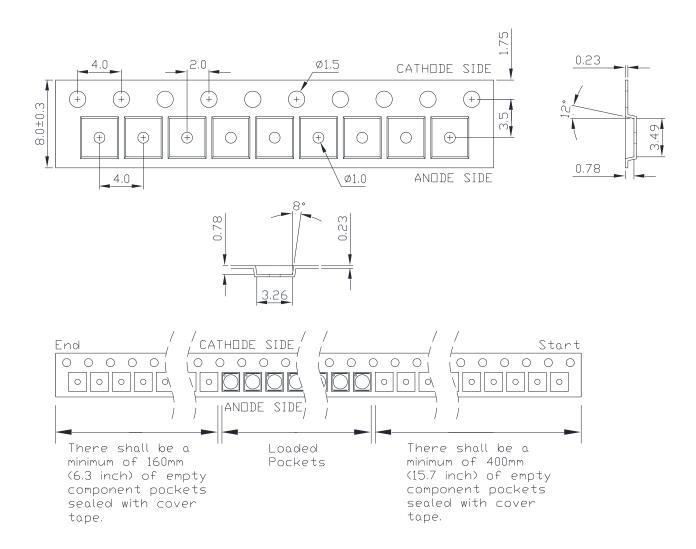
Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly	
Average Ramp-Up Rate	3°C / second max.	3°C / second max.	
(T <sub>Smax</sub> to T <sub>p</sub> )	5 C/ Second Illax.		
Preheat			
<ul><li>Temperature Min (T<sub>Smin</sub>)</li></ul>	100°C	150°C	
<ul><li>– Temperature Max (T<sub>Smax</sub>)</li></ul>	150°C	200°C	
– Time (t <sub>Smin</sub> to t <sub>Smax</sub> )	60-120 seconds	60-180 seconds	
Time maintained above:			
– Temperature (T <sub>L</sub> )	183°C	217°C	
– Time (t <sub>L</sub> )	60-150 seconds	60-150 seconds	
Peak/Classification Temperature (T <sub>P</sub> )	240°C	260°C	
Time Within 5°C of Actual Peak	10-30 seconds	20-40 seconds	
Temperature (t <sub>p</sub> )	10-30 Seconds		
Ramp-Down Rate	6°C/second max.	6°C/second max.	
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.	



- We recommend using the M705-S101-S4 solder paste from SMIC (Senju Metal Industry Co., Ltd.) for lead-free soldering.
- Do not use solder pastes with post reflow flux residue>47%. (58Bi-42Sn eutectic alloy, etc) This kind
  of solder pastes may cause a reliability problem to LED.
- All temperatures refer to topside of the package, measured on the package body surface.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a
  double-head soldering iron should be used. It should be confirmed beforehand whether the
  characteristics of the LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than three times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.



### **Emitter Reel Packaging**

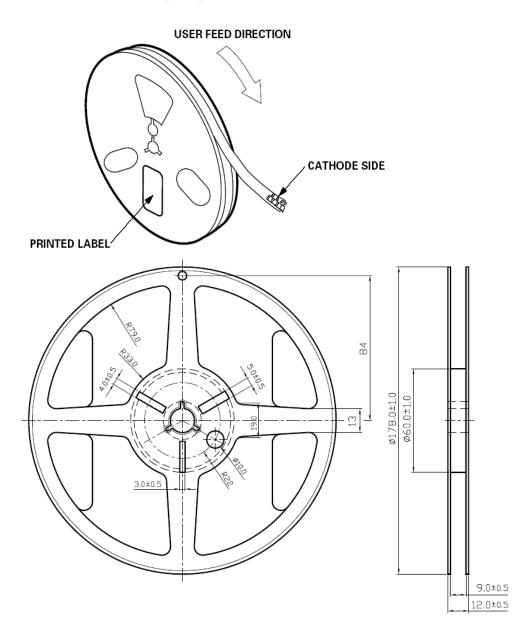


#### Notes:

- 1. Drawing not to scale.
- 2. All dimensions are in millimeters.
- 3. Unless otherwise indicated, tolerances are  $\pm\,0.1\text{mm}.$



# **Emitter Reel Packaging**



#### Notes:

- 1. Empty component pockets sealed with top cover tape.
- 2. 3000 pieces per reel.
- 3. Drawing not to scale.
- 4. All dimensions are in millimeters.



### **Precaution for Use**

Storage

Please do not open the moisture barrier bag (MBB) more than one week. This may cause the leads of LED discoloration. We recommend storing ProLight's LEDs in a dry box after opening the MBB. The recommended storage conditions are temperature 5 to 30 °C and humidity less than 40% RH. It is also recommended to return the LEDs to the MBB and to reseal the MBB.

- The slug is is not electrically neutral. Therefore, we recommend to isolate the heat sink.
- We recommend using the M705-S101-S4 solder paste from SMIC (Senju Metal Industry Co., Ltd.) for lead-free soldering.
- Do not use solder pastes with post reflow flux residue>47%. (58Bi-42Sn eutectic alloy, etc) This kind of solder pastes may cause a reliability problem to LED.
- Any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temperature after soldering.
- Please avoid rapid cooling after soldering.
- Components should not be mounted on warped direction of PCB.
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a heat plate should be used. It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When cleaning is required, isopropyl alcohol should be used.
- When the LEDs are illuminating, operating current should be decide after considering the package maximum temperature.
- The appearance, specifications and flux bin of the product may be modified for improvement without notice. Please refer to the below website for the latest datasheets. http://www.prolightopto.com/

### **Handling of Silicone LEDs**

Notes for handling of silicone LEDs

- Please do not use a force of over 0.3kgf impact or pressure on the silicone, otherwise it will cause a catastrophic failure.
- The LEDs should only be picked up by making contact with the sides of the LED body.
- Avoid touching the silicone especially by sharp tools such as Tweezers.
- Avoid leaving fingerprints on the silicone.
- Please store the LEDs away from dusty areas or seal the product against dust.
- When populating boards in SMT production, there are basically no restrictions regarding the form of the pick and place nozzle, except that mechanical pressure on the silicone lens must be prevented.
- Please do not mold over the silicone lens with another resin. (epoxy, urethane, etc)



